164-192 MHz frequency band
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<th>DLP® Products</th>
<th>DSP</th>
<th>Clocks and Timers</th>
<th>Interface</th>
<th>Logic</th>
<th>Power Mgmt</th>
<th>Microcontrollers</th>
<th>RFID</th>
<th>OMAP Applications Processors</th>
<th>Wireless Connectivity</th>
</tr>
</thead>
</table>

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<table>
<thead>
<tr>
<th>Automotive and Transportation</th>
<th>Communications and Telecom</th>
<th>Computers and Peripherals</th>
<th>Consumer Electronics</th>
<th>Energy and Lighting</th>
<th>Industrial</th>
<th>Medical</th>
<th>Security</th>
<th>Space, Avionics and Defense</th>
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